20A, 60V Trench Schottky Surface Mount Rectifier

FEATURES

• AEC-Q101 qualified

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- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Lower power loss/ high efficiency
- High forward surge capability
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Low voltage, high freq. inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

- Case: PDFN56
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.096g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	20	А	
V _{RRM}	60	V	
I _{FSM}	200	А	
T _{J MAX}	150	°C	
Package	PDFN56		
Configuration	Single die		





PDFN56



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	TSN520M60H	UNIT
Marking code on the device		520M60	
Repetitive peak reverse voltage	V _{RRM}	60	V
Reverse voltage, total rms value	V _{R(RMS)}	42	V
Forward current	I _F	20	Α
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	200	А
Junction temperature	TJ	- 55 to +150	°C
Storage temperature	T _{STG}	- 55 to +150	°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R _{θJL}	7	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 10A, T_J = 25^{\circ}C$	V _F	0.43	-	V
	$I_F = 20A, T_J = 25^{\circ}C$		0.48	0.58	V
	$I_F = 10A, T_J = 125^{\circ}C$		0.33	-	V
	$I_F = 20A, T_J = 125^{\circ}C$		0.42	0.52	V
Reverse current @ rated $V_R^{(2)}$	T _J = 25°C	I _R	-	500	μA
	T _J = 125°C		-	100	mA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TSN520M60H	PDFN56	6,000 / Tape & Reel



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

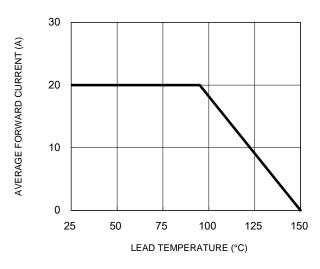


Fig.3 Typical Reverse Characteristics

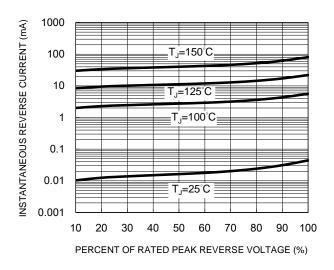


Fig.1 Forward Current Derating Curve Fig.2 Typical Junction Capacitance

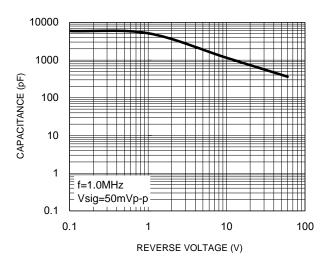
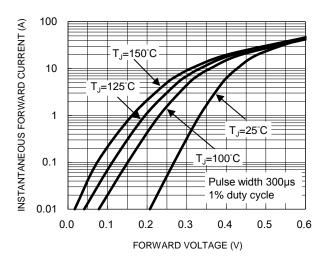


Fig.4 Typical Forward Characteristics

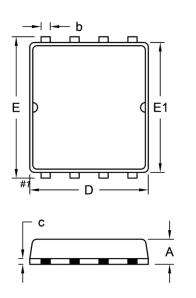


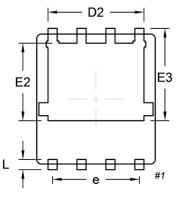


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PACKAGE OUTLINE DIMENSIONS

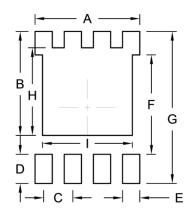
PDFN56





DIM.	Unit (mm)		Unit	(inch)
DIN.	Min.	Max.	Min.	Max.
А	0.95	1.25	0.037	0.049
b	0.25	0.55	0.010	0.022
с	0.10	0.40	0.004	0.016
D	5.05	5.35	0.199	0.211
D2	4.06	4.36	0.160	0.172
Е	6.00	6.40	0.236	0.252
E1	5.55	5.85	0.219	0.230
E2	3.25	3.55	0.128	0.140
E3	3.90	4.20	0.154	0.165
е	3.81	3.81(TYP.)		(TYP.)
L	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	4.56	0.180
В	4.52	0.178
С	1.27	0.050
D	1.27	0.050
E	0.75	0.030
F	4.32	0.170
G	6.61	0.260
Н	3.81	0.150
I	3.91	0.154

MARKING DIAGRAM



P/N	= Marking Code
1000	Data Oada

- YW = Date Code
- F = Factory Code



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